

1 2 3 4 5 6 7 8 9

F

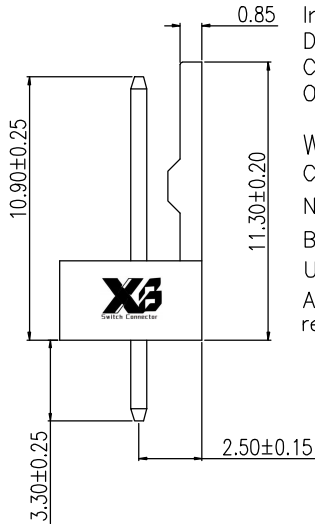
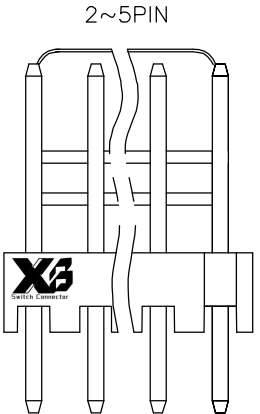
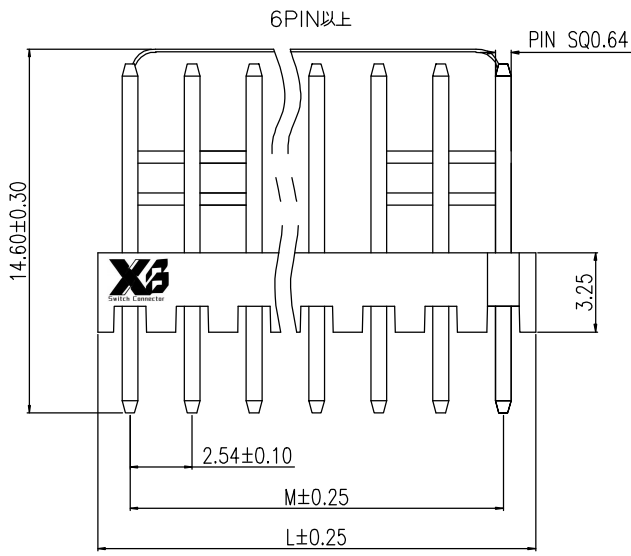
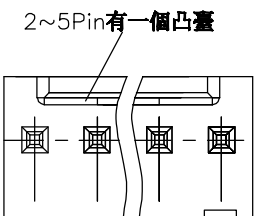
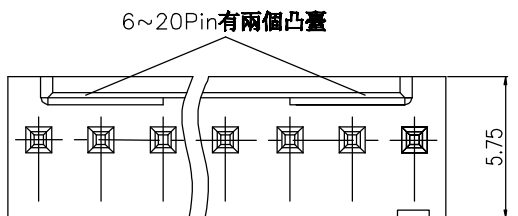
E

D

C

B

A



**Specifications**  
 Voltage Rating: 250V(AC,DC)  
 Current Rating: 4A(AC,DC)  
 Insulation Resistance: 1000MΩ Min.  
 Dielectric Withstanding: 1000VAC/minute  
 Contact Resistance: 20mΩ Max.  
 Operating Temperature: -25°C to +85°C

**Wafer**  
 Contact Material: Brass  
 Ni 30u" MIN Whole SN:70u" MIN (亮錫)  
 Base Material: High Temperature Thermoplastic  
 UL 94V-0 Nylon 66 or the equivalent material  
 All materials must meet XI BANG  
 requirement for environment protection.

No. of PIN/ROW	Dimension		Information
	L	M	
02	4.98	2.54	
03	7.52	5.08	
04	10.06	7.62	
05	12.60	10.16	
06	15.14	12.70	
07	17.68	15.24	
08	20.22	17.78	
09	22.76	20.32	
10	25.30	22.86	
11	27.80	25.40	
12	30.38	27.94	
13	32.92	30.48	
14	35.46	33.02	
15	38.00	35.56	
16	40.54	38.10	
17	43.08	40.64	
18	45.62	43.18	
19	48.16	45.72	
20	50.70	48.26	

### Ordering Information

Recommended P.C.Board  
 Hole Layout



**XB-X254-PCB-103-0402A002E5BN XX XX A 002 E 5 B X**

ON. of Pins per row 02~20  
 Standard Plating 01=Tin  
 Selective plating 02=Gold Flash  
 Color 5=米黄色  
 Standard N=PE Bag  
 Selective B=Tray

**东莞市溪榜电子有限公司**  
 DONG GUAN XI BANG ELECTRONICS CO., LTD

GENERAL TOLERANCE	
X.* ± 1.5*	X. ± 0.30
.X* ± 1.0*	.X ± 0.20
.XX* ± 0.5*	.XX ± 0.15
.XXX* ± 0.3*	.XXX ± 0.10

DESIGN:  
 CHECKED:  
 AUDITED:

DATE:  
 DATE:  
 DATE:

DWG. NO.  
 XB-X254-PCB-103-0402A002E5BN  
 PART NO.

TITLE.  
 PITCH 2.54 WAFER

REV. 04 UNIT. mm SCALE. 4:1 PAGE. 1/1

1 2 3 4 5 6 7 8 9